

## **Technical Data Sheet**

# 0603 Package Chip LED (0.4mm Height)

## 19-217/G7C-BL1M1BY/3T

#### **Features**

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-free.

#### **Descriptions**

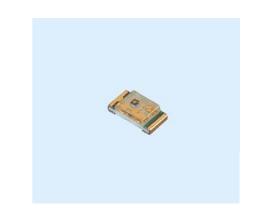
- The 19-217 SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

#### **Applications**

- Automotive: backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

#### **Device Selection Guide**

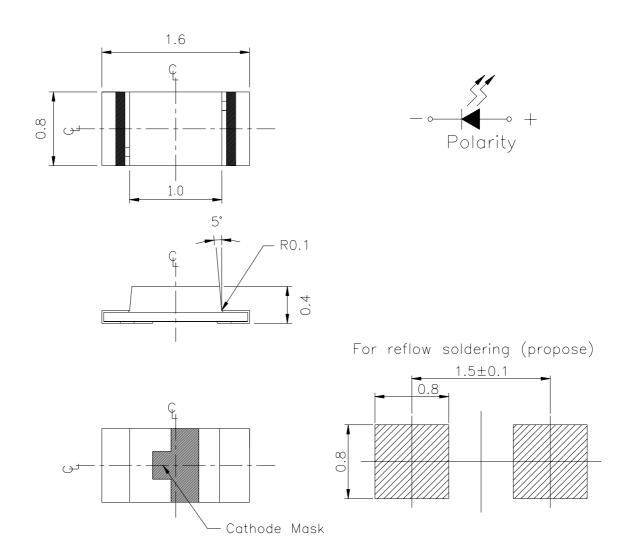
	Chip		Lens Color	
Part No.	Material	Emitted Color		
19-217/G7C-BL1M1BY/3T	AlGaInP	Brilliant Yellow Green	Water Clear	



Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 1 of 10 Device No.: DSE-197-G04 Prepared date: 26-Nov-2004 Prepared by: Jessica Chang



# **Package Outline Dimensions**



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 2 of 10

Device No.: DSE-197-G04 Prepared date: 26-Nov-2004 Prepared by: Jessica Chang



# **Absolute Maximum Ratings (Ta=25°C)**

Parameter	Symbol	Rating	Unit
Reverse Voltage	$V_R$	5	V
Forward Current	<b>I</b> F	25	mA
Operating Temperature	Topr	-40 ~ +85	$^{\circ}\!\mathbb{C}$
Storage Temperature	Tstg	-40 ~ +90	$^{\circ}\!\mathbb{C}$
Soldering Temperature	Tsol	260 (for 5 seconds)	$^{\circ}\!\mathbb{C}$
Electrostatic Discharge	ESD	2000	V
Power Dissipation	Pd	60	mW
Peak Forward Current (Duty 1/10 @1KHz)	IFP	60	mA

# **Electro-Optical Characteristics (Ta=25°C)**

		•				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	Iv	11.5		22.5	mcd	
Peak Wavelength	λр		575		nm	
Dominant Wavelength	λd	567.5		575.5	nm	
Spectrum Radiation Bandwidth	Δλ		20		nm	IF=5mA
Viewing Angle	2 \theta 1/2		120		deg	
Forward Voltage	VF	1.75		2.35	V	
Reverse Current	Ir			10	$\mu$ A	V <sub>R</sub> =5V

#### **Notes:**

1.Tolerance of Luminous Intensity ±10%

2.Tolerance of Dominant Wavelength ±1nm

3.Tolerance of Forward Voltage ±0.1V

Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 3 of 10

Device No.: DSE-197-G04 Prepared date: 26-Nov-2004 Prepared by: Jessica Chang



## Bin Range Of Dom. Wavelength

Group	Bin	Min	Max	Unit	Condition	
В	C15	567.5	569.5			
	C16	569.5	571.5		IF=5mA	
	C17	571.5	573.5	nm		
	C18	573.5	575.5			

### **Bin Range Of Luminous Intensity**

Bin	Min	Max	Unit	Condition
L1	11.5	14.5		
L2	14.5	18.0	mcd	IF=5mA
M1	18.0	22.5		

### **Bin Range Of Forward Voltage**

Group	Bin	Min	Max	Unit	Condition	
В	0	1.75	1.95			
	1	1.95	2.15	V	I <sub>F</sub> =5mA	
	2	2.15	2.35			

#### **Notes:**

1.Tolerance of Luminous Intensity ±10%

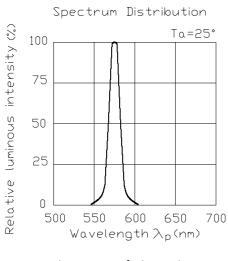
2.Tolerance of Dominant Wavelength ±1nm

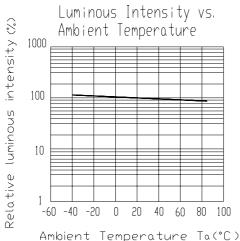
3.Tolerance of Forward Voltage ±0.1V

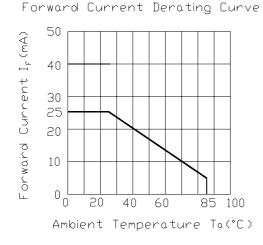
Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 4 of 10

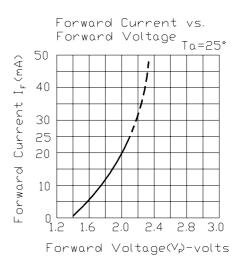
Device No.: DSE-197-G04 Prepared date: 26-Nov-2004 Prepared by: Jessica Chang

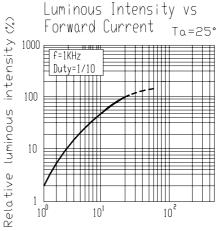
# **Typical Electro-Optical Characteristics Curves**

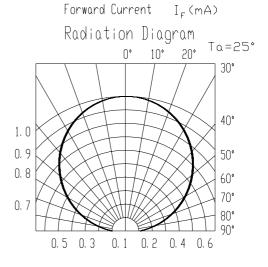












Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 5 of 10 Device No.: DSE-197-G04 Prepared date: 26-Nov-2004 Prepared by: Jessica Chang

### Label explanation

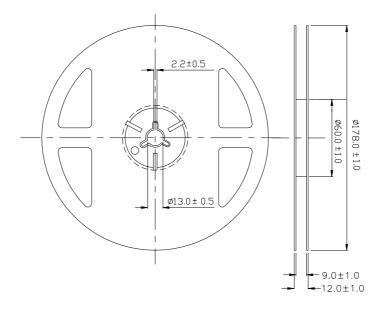
**CAT: Luminous Intensity Rank** 

**HUE: Dom. Wavelength Rank** 

**REF: Forward Voltage Rank** 



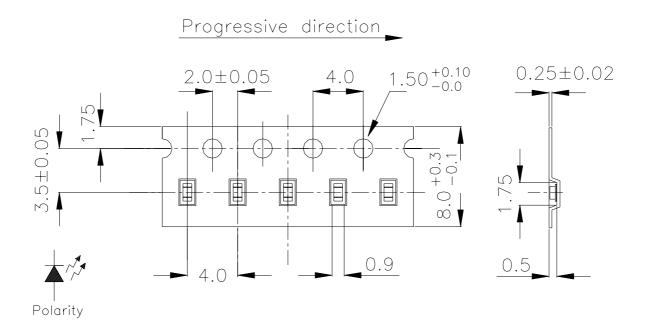
#### **Reel Dimensions**



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

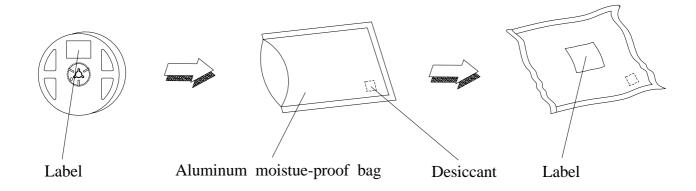
Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 6 of 10 Device No.: DSE-197-G04 Prepared date: 26-Nov-2004 Prepared by: Jessica Chang

## Carrier Tape Dimensions: Loaded quantity 3000 PCS per reel



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

### **Moisture Resistant Packaging**



Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 7 of 10 Device No.: DSE-197-G04 Prepared date: 26-Nov-2004 Prepared by: Jessica Chang



## **Reliability Test Items And Conditions**

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min		0/1
2	Temperature Cycle	$H: +100^{\circ}\mathbb{C}$ 15min $\int$ 5 min $L: -40^{\circ}\mathbb{C}$ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H:+100°C 5min ∫ 10 sec L:-10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°€	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C/85%RH	1000 Hrs.	22 PCS.	0/1

Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 8 of 10

Device No.: DSE-197-G04 Prepared date: 26-Nov-2004 Prepared by: Jessica Chang

#### **Precautions For Use**

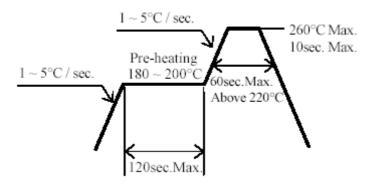
1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at 30°C or less and 90%RH or less.
- 2.3 The LEDs should be used within a year.
- 2.4 After opening the package, the LEDs should be kept at 30°C or less and 70%RH or less.
- 2.5 The LEDs should be used within 168 hours (7 days) after opening the package.
- 2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment :  $60\pm5^{\circ}$ C for 24 hours.

- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 9 of 10

Device No.: DSE-197-G04 Prepared date: 26-Nov-2004 Prepared by: Jessica Chang

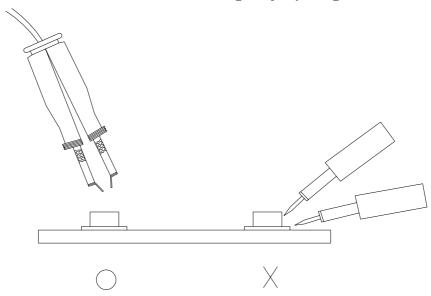


#### 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 280°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

#### 5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



EVERLIGHT ELECTRONICS CO., LTD.

Office: No 25, Lane 76, Sec 3, Chung Yang Rd, Tucheng, Taipei 236, Taiwan, R.O.C Tel: 886-2-2267-2000, 2267-9936

Fax: 886-2267-6244, 2267-6189, 2267-6306

http://www.everlight.com

Everlight Electronics Co., Ltd. http://www.everlight.com Rev. 1 Page: 10 of 10 Device No.: DSE-197-G04 Prepared date: 26-Nov-2004 Prepared by: Jessica Chang